

AOSP62530

150V N-Channel AlphaSGT™

General Description

• Trench Power AlphaSGTTM technology

• Low R_{DS(ON)}

Low Gate Charge

Applications

Product Summary

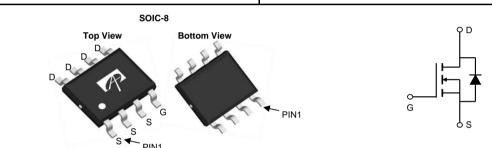
 $\begin{array}{lll} V_{DS} & 150V \\ I_{D} \; (at \, V_{GS} \! = \! 10V) & 5A \\ R_{DS(ON)} \; (at \, V_{GS} \! = \! 10V) & < 63 m\Omega \\ R_{DS(ON)} \; (at \, V_{GS} \! = \! 4.5V) & < 70 m\Omega \end{array}$

100% UIS Tested

100% Old Tested



• Primary Switch for 48V systems



Orderable Part Number Package Type		Form	Minimum Order Quantity
AOSP62530	SO-8	Tape & Reel	3000

Parameter	Symbol	Maximum	Units	
Drain-Source Voltage	V_{DS}	150	V	
Gate-Source Voltage	V_{GS}	±20	V	
Continuous Drain T _A =25°C		5		
Current T _A =70°C	I _D	3.8	A	
Pulsed Drain Current ^C	I _{DM}	20		
Avalanche Current ^C	I _{AS}	14	A	
Avalanche energy L=0.3mH ^C	E _{AS}	29	mJ	
T _A =25°C	Ь	3.1	W	
Power Dissipation B T _A =70°C	P _D	2.0	T vv	
Junction and Storage Temperature Range	je T _J , T _{STG}	-55 to 150	°C	

Thermal Characteristics						
Parameter		Symbol	Тур	Max	Units	
Maximum Junction-to-Ambient A	t ≤ 10s	D	31	40	°C/W	
Maximum Junction-to-Ambient AD	Steady-State	$R_{\theta JA}$	59	75	°C/W	
Maximum Junction-to-Lead	Steady-State	$R_{\theta JL}$	16	24	°C/W	



Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units
STATIC I	PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$		150			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =150V, V _{GS} =0V				1	μA
			T _J =55°C			5	μΛ
I _{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} =±20V				±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$		1.7	2.2	2.7	V
	Static Drain-Source On-Resistance	V_{GS} =10V, I_D =5A			52	63	mΩ
R _{DS(ON)}			T _J =125°C		95	115	
		V_{GS} =4.5V, I_D =2A			56	70	mΩ
g _{FS}	Forward Transconductance	$V_{DS}=5V$, $I_{D}=5A$			14		S
V_{SD}	Diode Forward Voltage	I _S =1A, V _{GS} =0V			0.7	1	V
Is	Maximum Body-Diode Continuous Current					4	Α
DYNAMI	CPARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =75V, f=1MHz			675		pF
Coss	Output Capacitance				78		pF
C _{rss}	Reverse Transfer Capacitance				4		pF
R_g	Gate resistance	f=1MHz		1.5	3.0	4.5	Ω
SWITCH	NG PARAMETERS						
Q _g (10V)	Total Gate Charge	V _{GS} =10V, V _{DS} =75V, I _D =5A			11.5	20	nC
Q _g (4.5V)	Total Gate Charge				5.5	10	nC
Q_{gs}	Gate Source Charge				2.0		nC
Q_{gd}	Gate Drain Charge				2.5		nC
$t_{D(on)}$	Turn-On DelayTime				6.0		ns
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =75V, R_L =15 Ω , R_{GEN} =3 Ω			3.0		ns
t _{D(off)}	Turn-Off DelayTime				20		ns
t _f	Turn-Off Fall Time				5		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =5A, di/dt=500A/μs			37		ns
Q_{rr}	Body Diode Reverse Recovery Charge	_t I _F =5A, di/dt=500A/μs			210		nC

A. The value of R_{0JA} is measured in a still air environment with T_A =25° C. The value in any given application depends on the user's specific board

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B. The power dissipation P_D is based on $T_{J(MAX)}$ =150° C, using \leq 10s junction-to-ambient thermal resistance. C. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$ =150° C. Ratings are based on low frequency and duty cycles to keep initialT₁=25° C.

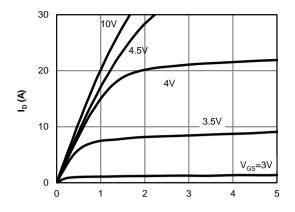
D. The R_{0JA} is the sum of the thermal impedance from junction to lead R_{0JL} and lead to ambient. E. The static characteristics in Figures 1 to 6 are obtained using <300 μ s pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-ambient thermal impedance which is assuming a maximum junction temperature of T_{JIMAXI}=150° C. The SOA curve provides a single pulse rating.

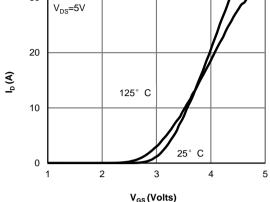
G. The spike duty cycle 5% max, limited by junction temperature TJ(MAX)=125° C.



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

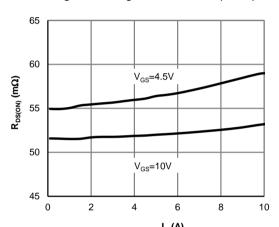


 $V_{\rm DS}$ (Volts) Figure 1: On-Region Characteristics (Note E)

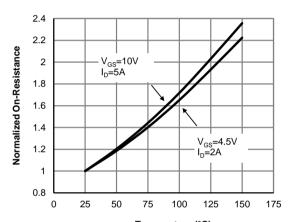


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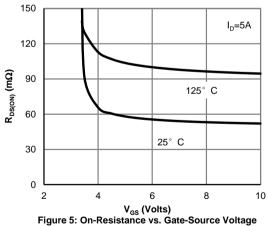
V_{GS} (Volts) Figure 2: Transfer Characteristics (Note E)



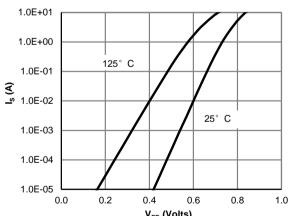
 $\label{eq:local_potential} \mathbf{I_{D}}\left(\mathbf{A}\right)$ Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)



Temperature (°C)
Figure 4: On-Resistance vs. Junction Temperature
(Note E)



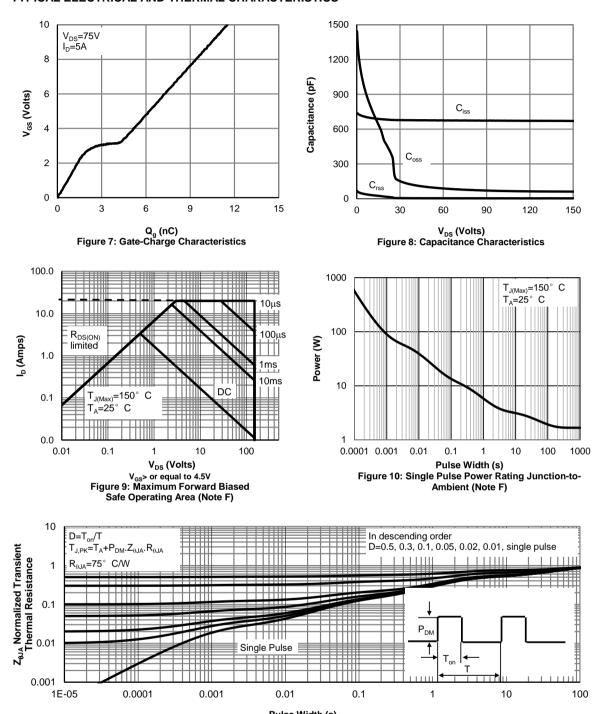
(Note E)



V_{SD} (Volts) Figure 6: Body-Diode Characteristics (Note E)



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



Pulse Width (s)
Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

Figure A: Gate Charge Test Circuit & Waveforms

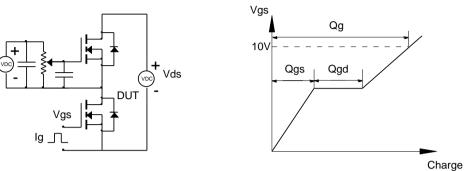


Figure B: Resistive Switching Test Circuit & Waveforms

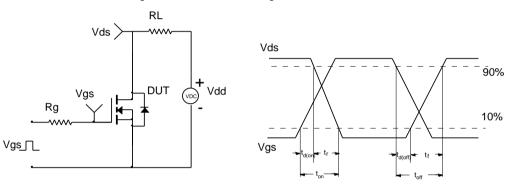


Figure C: Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

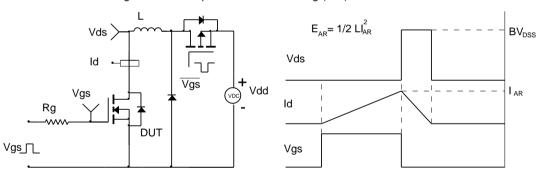
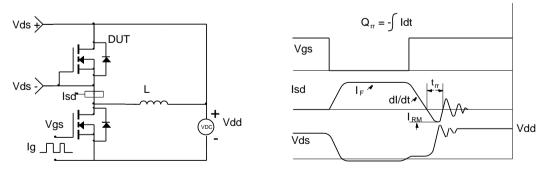


Figure D: Diode Recovery Test Circuit & Waveforms



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